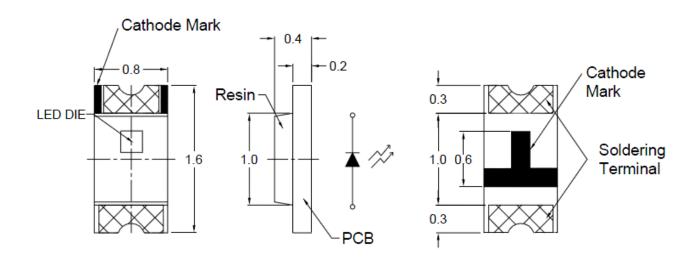
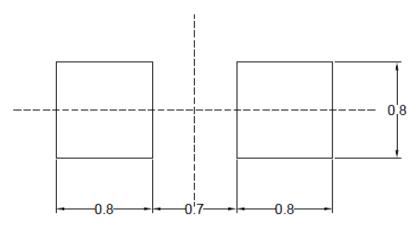


1.6 x 0.8 x 0.4 mm Green SMD LED

### PACKAGE OUTLINES



#### RECOMMENDED PAD LAYOUT



#### NOTES:

- 1. All dimensions are in millimeters;
- 2. Tolerances are  $\pm 0.2$ mm unless otherwise noted.

Part Number	Material	Color		
Fait Nulliper		Emitted	Lens	
L196L-MPGC-TR	InGaN/GaN	Green	Water Clear	



1.6 x 0.8 x 0.4 mm Green SMD LED

ABSOLUTE MAXIMUM RATINGS	(Ta=25°C)		
Parameter	Symbol	Value	Unit
Forward current	lf	20	mA
Reverse current @5V	lr	50	μA
Power dissipation	Pd	80	mW
Peak forward current (1/10 @ 10kHz)	lfp	100	mA
Electrostatic Discharge	ESD	150	V
Operating temperature range	Topr	-40~+85	٥C
Storage temperature range	Tstg	-40~+90	٥C
Soldering Temperature	Tsol	Max 260°C for 5 sec Max	

### **OPTICAL-ELECTRICAL CHARACTERISTICS**

(Ta=25°C)

					`	,
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Spectral half bandwidth	Δλ	I <sub>F</sub> = 20mA		36		nm
Peak Wavelength	λP	I <sub>F</sub> = 20mA		518		nm
Dominant wavelength	λD	I <sub>F</sub> = 20mA		525		nm
Forward Voltage	Vf	I <sub>F</sub> = 20mA		3.5	4.0	V
Luminous intensity	lv	I <sub>F</sub> = 20mA	200	500	800	mcd
Viewing angle at 50% lv	20 1⁄2	I <sub>F</sub> = 20mA		140		Deg

\*Note: 1. The forward voltage data did not include  $\pm 0.1V$  testing tolerance.

2. The luminous intensity data did not include  $\pm 15\%$  testing balance.

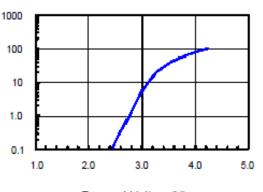


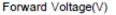
1.6 x 0.8 x 0.4 mm Green SMD LED

Relative Intensity Normalize @20mA

#### **OPTICAL CHARACTERISTIC CURVES**

Fig.1 Forward current vs. Forward Voltage





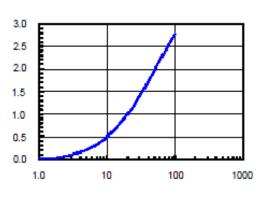
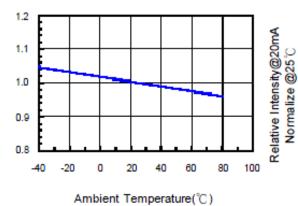


Fig.2 Relative Intensity vs. Forward Current

Forward Current(mA)

#### Fig.3 Forward Voltage vs. Temperature





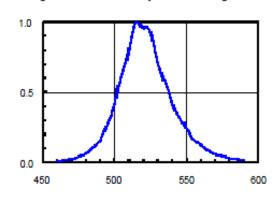
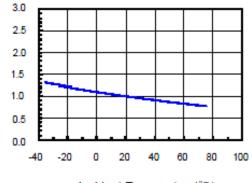
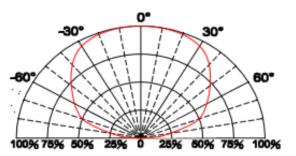


Fig.4 Relative Intensity vs. Temperature



Ambient Temperature(℃)

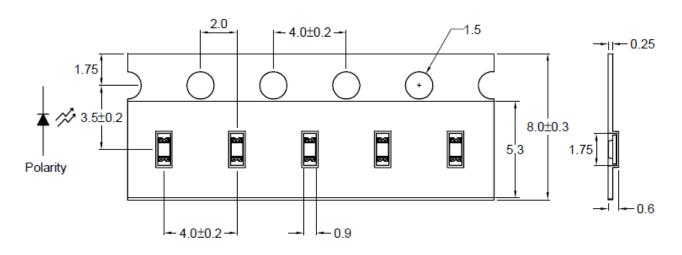
#### Fig.6 Directive Radiation





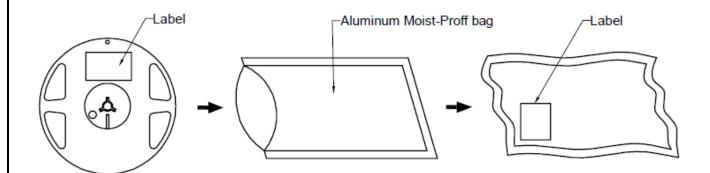
1.6 x 0.8 x 0.4 mm Green SMD LED

### **CARRIER TYPE DIMENSIONS**



Note: The tolerances unless mentioned is  $\pm 0.1$ mm, Angle  $\pm 0.5$ . Unit=mm.

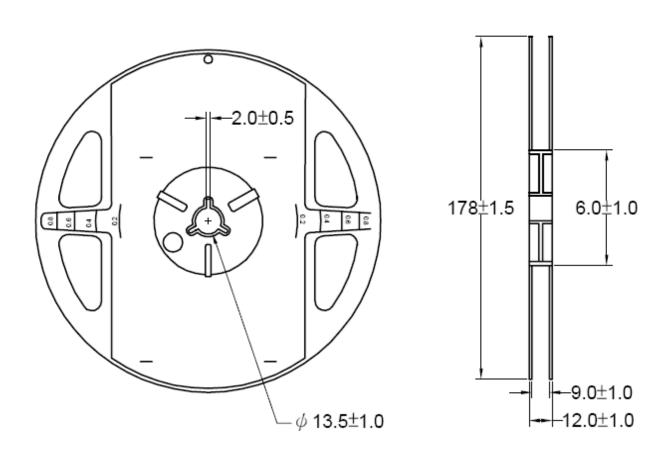
### PACKAGING SPECIFICATION





1.6 x 0.8 x 0.4 mm Green SMD LED

#### **REEL DIMENSIONS**



#### Notes:

- 1. Empty component pockets are sealed with top cover tape;
- 2. The maximum number of missing lamps is two;
- 3. The cathode is oriented towards the tape sprocket hole.
- 4. 4,000pcs/Reel



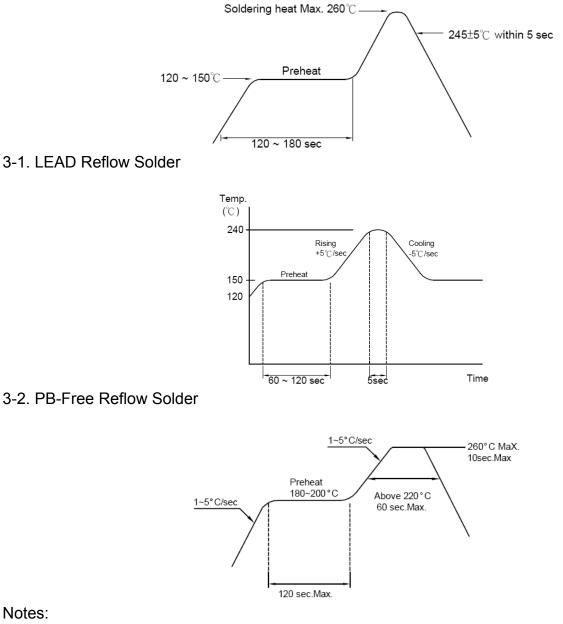
1.6 x 0.8 x 0.4 mm Green SMD LED

### RECOMMENDED SOLDERING CONDITIONS

1. Hand Solder

Basic spec is  $\leq 280^{\circ}$ C 3 sec one time only.

2. Wave Solder



Notes:

- 1. Reflow soldering should not be done more than two times.
- 2. When soldering, do not put stress on the LEDs during heating.
- 3. After soldering, do not warp the circuit board.



1.6 x 0.8 x 0.4 mm Green SMD LED

#### Precautions for use:

Storage time:

1. The operation of temperature and RH are: 5°C~35°C, RH60%.

2. Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp proof box with descanting agent. Considering the tape life, we suggest our customers to use our products within a year (from production date).

3. If opened more than one week in an atmosphere  $5^{\circ}$ C ~  $35^{\circ}$ C, RH60%, they should be treated at  $60^{\circ}$ C ±  $5^{\circ}$ C for 15hrs.

Drive Method:

LED is a current operated device, and therefore, require some kind of current limiting incorporated into the driver circuit. This current limiting typically takes the form of a current limiting resistor placed in a series with the LED.

Consider worst case voltage variations that could occur across the current limiting resistor. The forward current should not be allowed to change by more than 40% of its desired value.



(A) Recommended circuit.

(B) The difference of brightness between LED could be found due to the VF-IF characteristics of LED.

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED.

ESD (Electrostatic Discharge):

Static electricity or power surge will damage the LED. Use of a conductive wrist band or antielectrostatic glove is recommended when handling these LED. All devices, equipment and machinery must be properly grounded.



### 1.6 x 0.8 x 0.4 mm Green SMD LED

Classification	Test Item	Test Conditions	Number of Damaged	
Endurance Test	Operating Life Test	<ol> <li>Ta=under room temperature as per data sheet</li> <li>If=20mA</li> <li>t=1000 hrs (-24hrs, +72hrs)</li> </ol>	MIL-STD-750D:1026 MIL-STD-883D: 1005 JIS C 7021: B-1	
	High Temperature Storage Test	1. Ta=105°C±5°C 2. t=1000 hrs (-24hrs, +72hrs)	MIL-STD-883D:1008 JIS C 7021: B-10	
	Low Temperature Storage Test	1. Ta=40°C±5°C 2. t=1000 hrs (-24hrs, +72hrs)	JIS C 7021: B-12	
	High Temperature High Humidity Storage Test	1. Ta=65°C±5°C 2. RH=90%~95% 3. t=1000hrs	MIL-STD-202F:103B JIS C 7021: B-11	
Environmental Test	Thermal Shock Test	1. Ta= 105°C±5°C & -40°C±5°C (10min) (10min) 2. Total 10 cycles	MIL-STD-202F: 107D MIL-STD-750D: 1051 MIL-STD-883D: 1011	
	Solderability Test	<ol> <li>Tsol=235°C±5°C</li> <li>Immersion time 2±0.5sec</li> <li>Coverage ≥95% of the dipped surface</li> </ol>	MIL-STD-202F: 208D MIL-STD-750D: 2026 MIL-STD-883D: 2003 IEC 68 Part 2-20 JIS C 7021: A-4	
	Temperature Cycling	1. 105°C ~ 25°C ~ -55°C ~ 25°C 30 mins 5 mins 30 mins 5 mins 2. 10 cycles	MIL-STD-202F: 107D MIL-STD-750D: 1051 MIL-STD-883D: 1010 JIS C 7021: A-4	
	IR Reflow	1. T=260°C Max. 10sec.Max. 2. 6 Min	MIL-STD-750D:2031.2 J-STD-020	